NRVTSM245E

Surface Mount Trench Schottky Power Rectifier

POWERMITE[®] Power Surface Mount Package

Features

- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm²
- Supplied in 12 mm Tape and Reel
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink
- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- High Surge Capability
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free and Halide-Free Devices

Typical Applications

• Switching Power Supplies including Adapters & Flat Panel Displays

NTAT

- High Frequency and DC-DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation

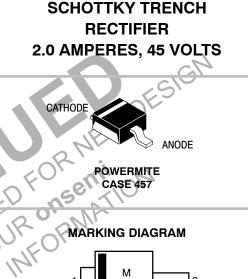
Mechanical Characteristics:

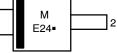
- Powermite is JEDEC Registered as D0-216AA
- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 16.3 mg (Approximately)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Maximum for 10 Seconds



ON Semiconductor®

www.onsemi.com







= Pb-Free Package (Marking Style 1)

ORDERING INFORMATION

Device	Package	Shipping [†]
NRVTSM245ET1G	Powermite (Pb–Free)	3000 / Tape & Reel
NRVTSM245ET3G	Powermite (Pb–Free)	12000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	45	V
Average Rectified Forward Current (T _L = 168°C)	۱ ₀	2.0	A
Peak Repetitive Forward Current (Square Wave, 20 kHz, T _L = 167°C)	I _{FRM}	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	50	A
Storage and Operating Junction Temperature Range (Note 1)	T _{stg} , T _J	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from

THERMAL CHARACTERISTICS

THERMAL CHARACTERISTICS		ESIGN		
Characteristic		Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead (Note 2)		ΨJCL	6.3	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)		R _{0JA}	82	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3)	E.	R _{0JA}	200	°C/W
ELECTRICAL CHARACTERISTICS	CO '	256.711	J.	

ELECTRICAL CHARACTERISTICS

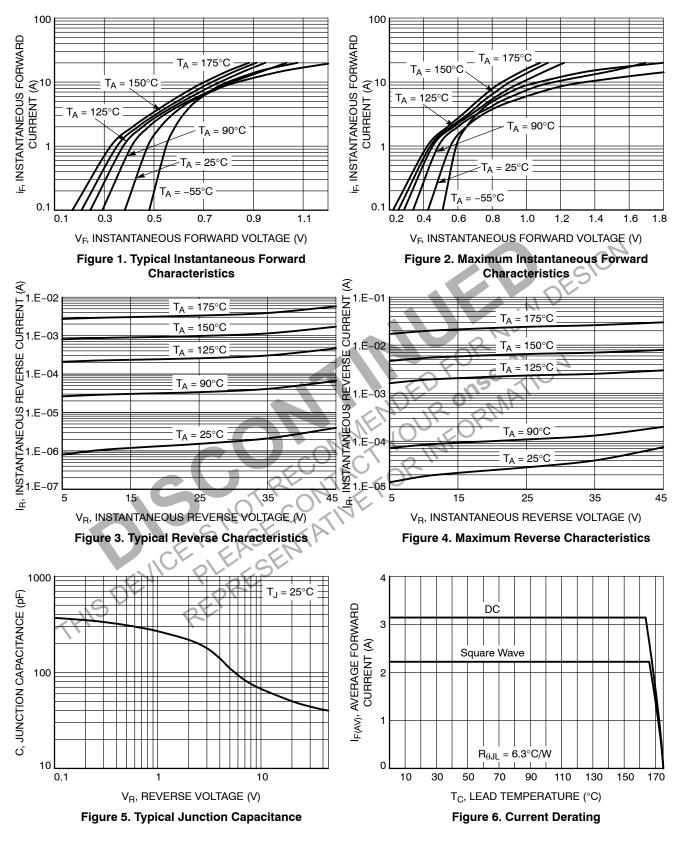
Characteristic	Value	Unit
Maximum Instantaneous Forward Voltage (Note 4) ($I_F = 2 A, T_J = 25^{\circ}C$) ($I_F = 2 A, T_J = 125^{\circ}C$)	0.65 0.58	V
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	75 3	μA mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Mounted with 700 mm² copper pad size (Approximately 1 in²) 1 oz FR4 Board.
Mounted with pad size approximately 20 mm² copper, 1 oz FR4 Board.
Pulse Test: Pulse Width ≤ 380 µs, Duty Cycle ≤ 2.0%.

THIS DE REPR

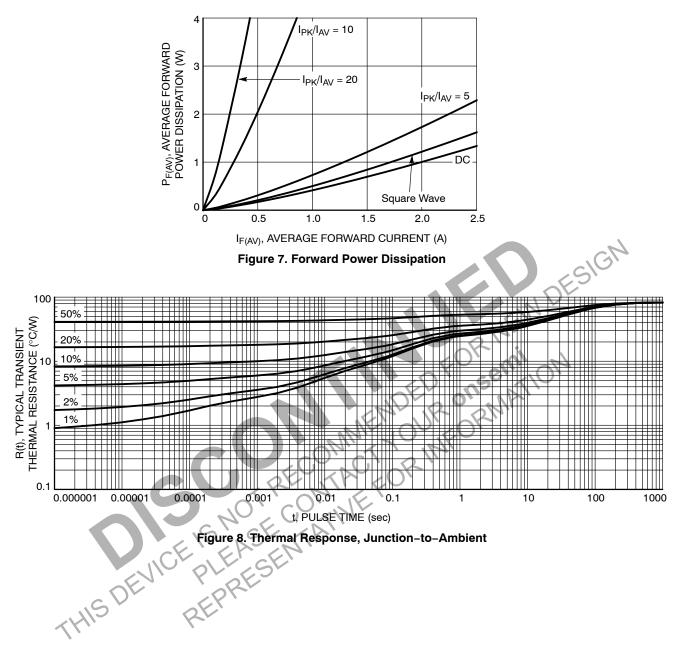
NRVTSM245E

TYPICAL CHARACTERISTICS

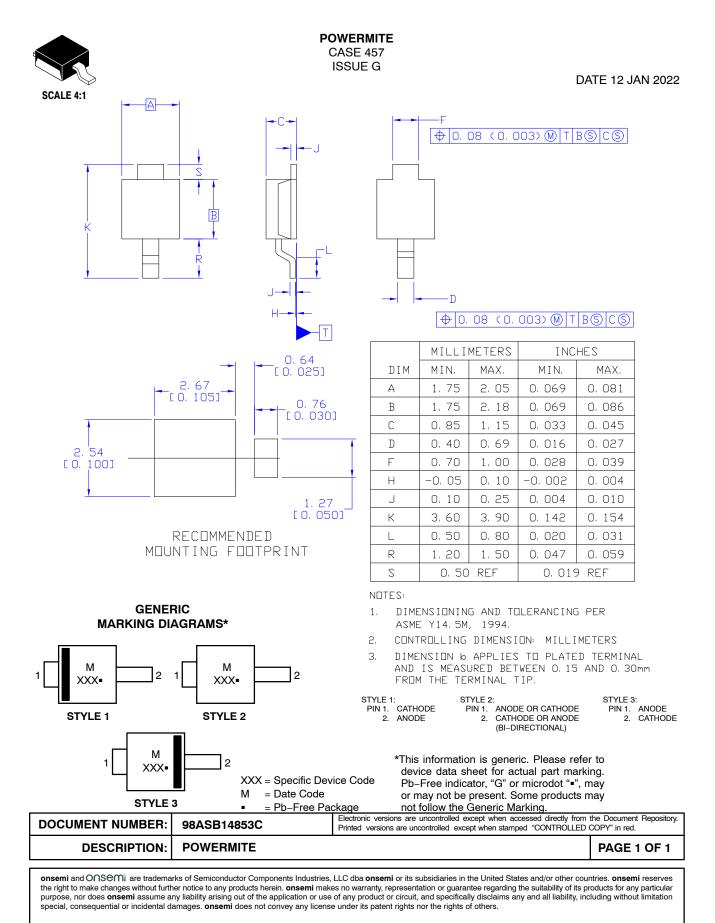


NRVTSM245E

TYPICAL CHARACTERISTICS







onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>